

# Next Generation High Throughput Production Processes & Inline Characterization for Si Solar Cells

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**ASYS:** Matthias Drews; **RCT Solutions:** Wolfgang Jooss;  
**ISC Konstanz:** Elina Schmid; **HTWK:** Stephan Schoenfelder; **Fraunhofer CSP:** Ringo Koepge

**PVCellTech Conference 2023**  
**Berlin, 14.03.2023**  
[www.ise.fraunhofer.de](http://www.ise.fraunhofer.de)

# Why High Throughput Production?

## 25 Years Production Technology [1]

### Module production 1997

- Shipments global: 110 **MWp/a**
- Module Price: 6 Euro/Wp

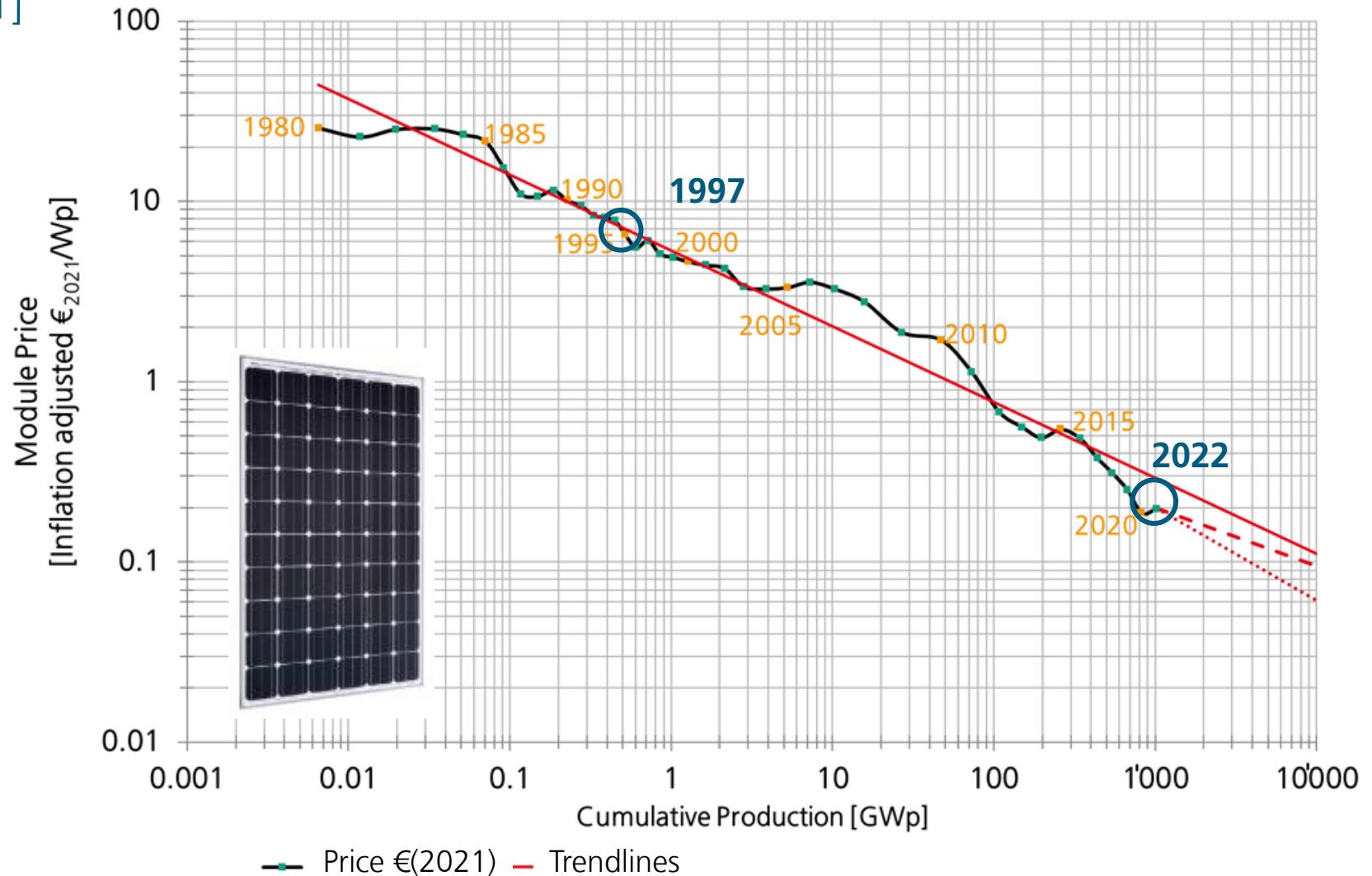
### Today 2022

- Shipments global\*: above 300 **GWp/a**
- Module Price\*: 0,2 -0.4 Euro/Wp

### Learning rate

Each time the cumulative PV module production doubled the price went down by about 25% for the last 41 years.

➔ **Market Size is the key for scaling / cost reduction**



[1] Preu et al., EUPVSEC, Milano 2022

\* Data form [www.PV-TECH.org](http://www.PV-TECH.org) / [www.pvxchange.com](http://www.pvxchange.com)

# Why High Throughput Production?

## Learning Rate Differentiation [1]

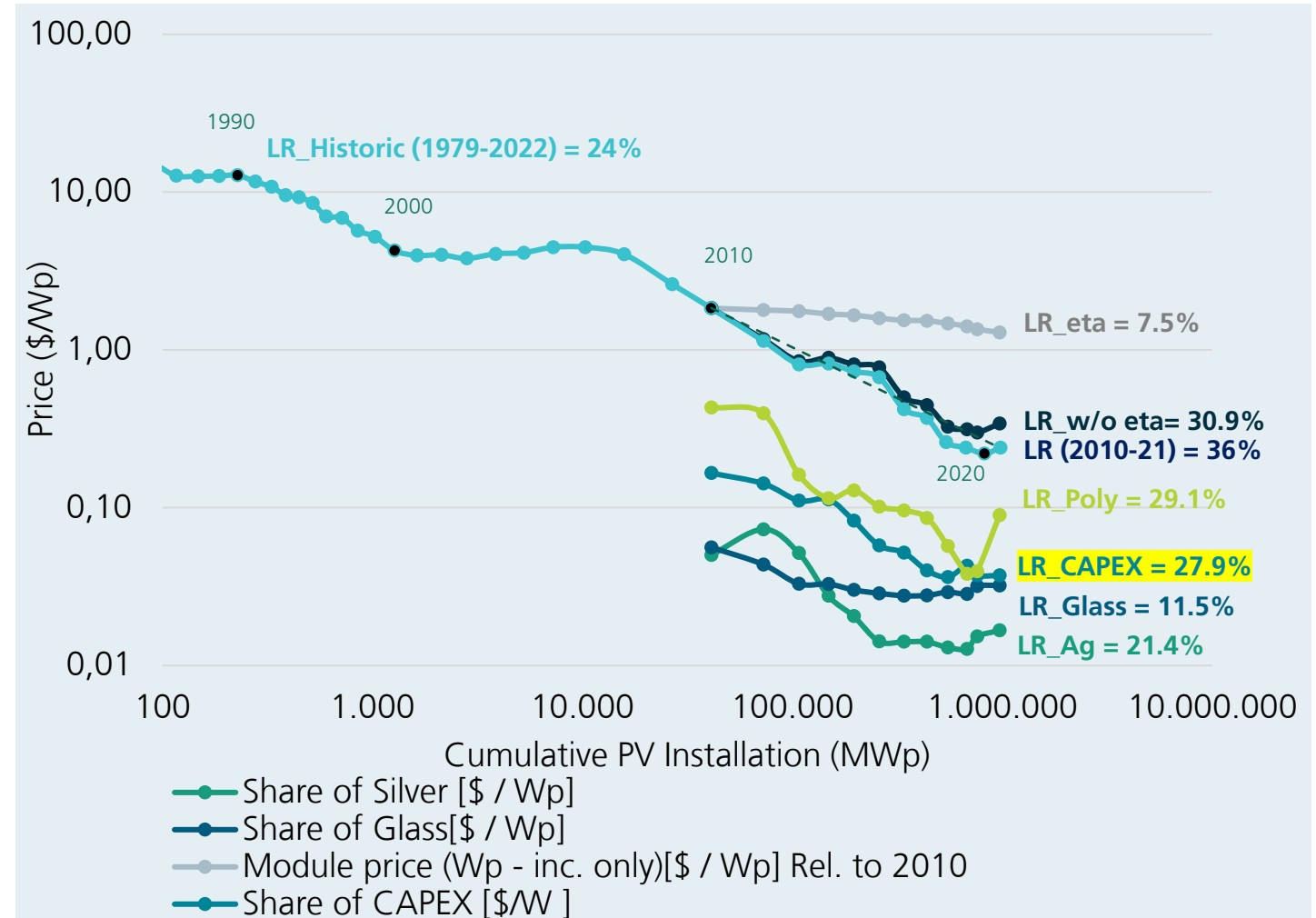
### Impact on cost:

- Module efficiency ( $\eta$ ) as a factor
- Differentiation in CAPEX and OPEX (here: Glass, Poly, Ag)

→ Silver and glass do not “learn” as quickly as CAPEX and “poly-Si”

→ **CAPEX learning is strongly supported by productivity increases**

→ More Details: Ralf Preu tomorrow

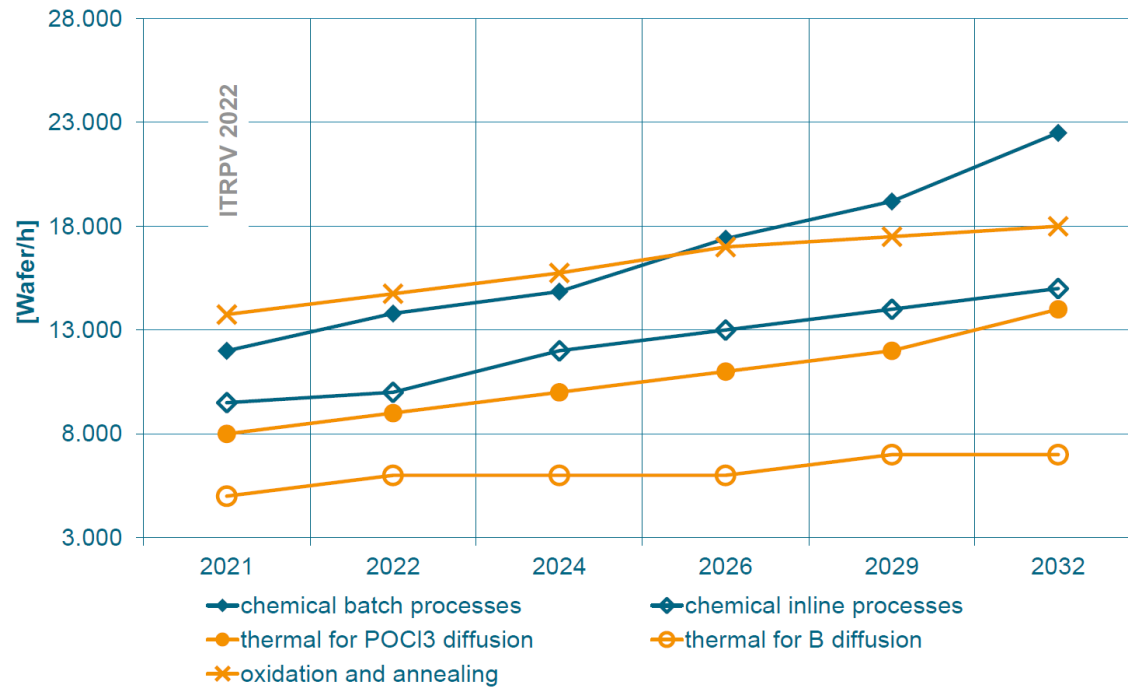


[1] Preu et al., EUPVSEC, Milano 2022

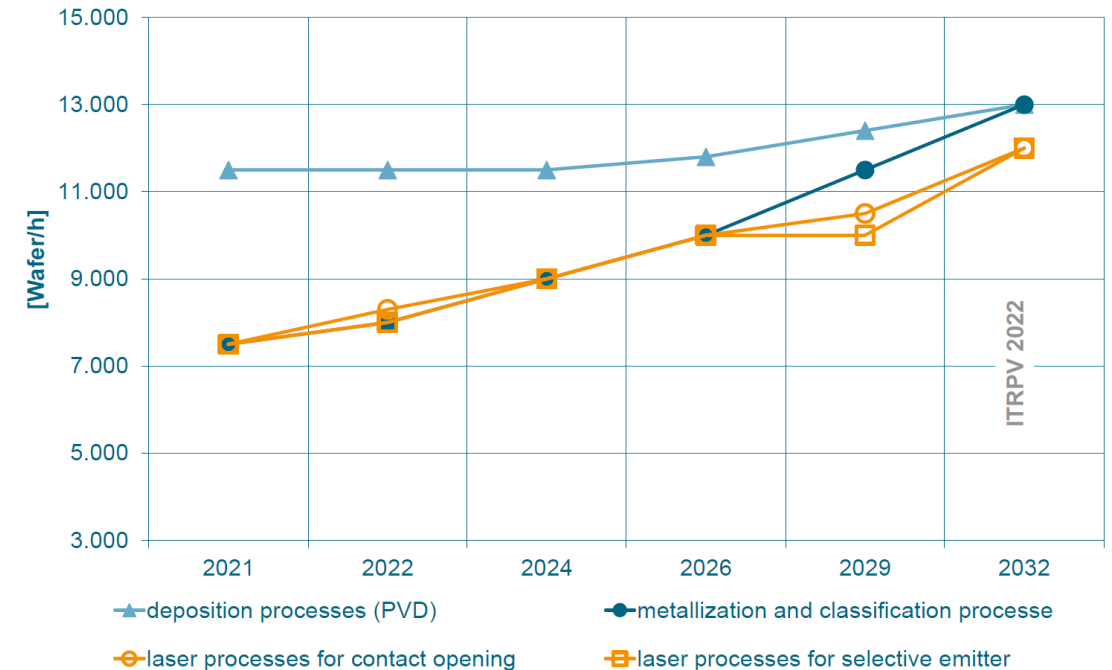
# What Throughput Rates will be Realistic?

## ITRPV Roadmap 2022 [2]

Progressive Scenario, new tools for wafer sizes M10 (182.0 x 182.0 mm<sup>2</sup>)



Progressive Scenario, new tools for wafer sizes M10 (182.0 x 182.0 mm<sup>2</sup>)



➤ ITRPV: Increase in throughput rates **by approx. factor 2** estimated in the **next ten years**

➤ The question is: How can we achieve high throughput rates?

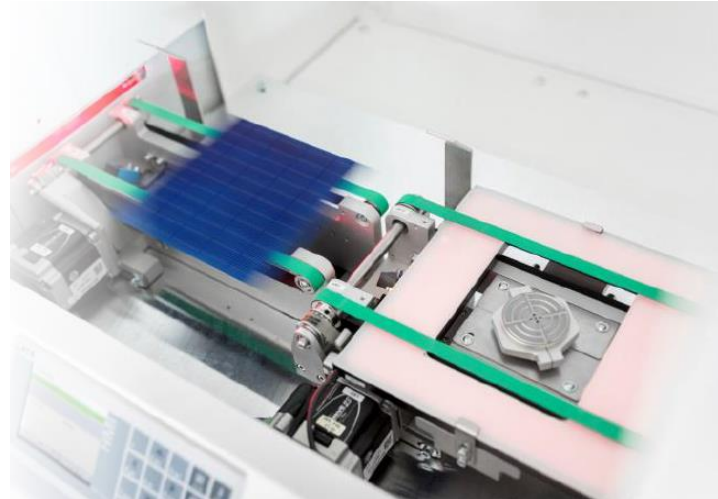
[2] VDMA, ITRPV, 2022



# What Throughput Rates will be Realistic?

## R&D Project NextTec – Short Project Description

- R&D project NextTec
- Consortium of equipment and metrology manufacturers as well as R&D institutes
- Funded by the German government
- Running Time: 01.05.2019 – 31.10.2022



Supported by:



Federal Ministry  
for Economic Affairs  
and Climate Action

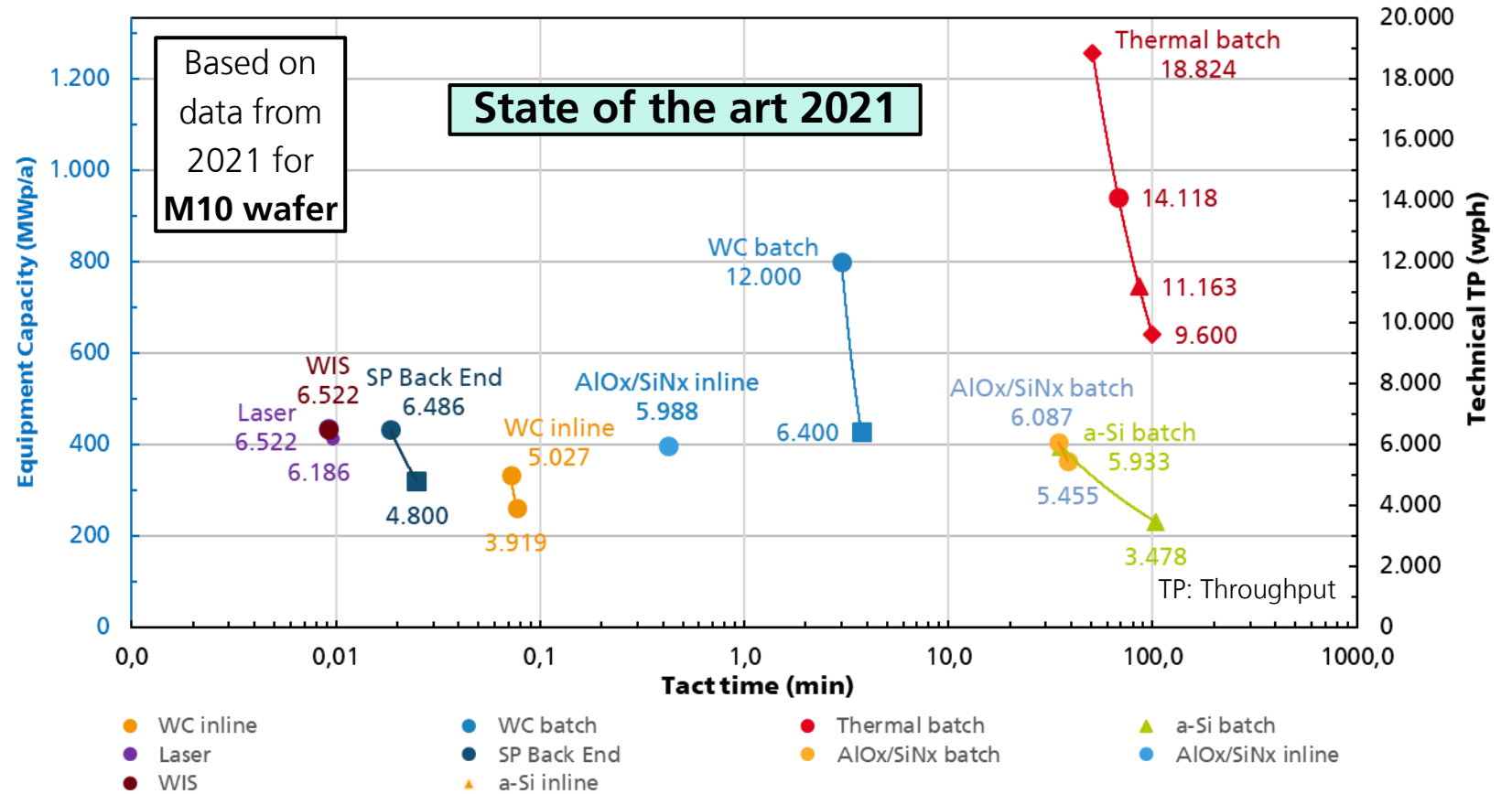
on the basis of a decision  
by the German Bundestag

Contract Nr: 03EE1001A



# High Throughput Production

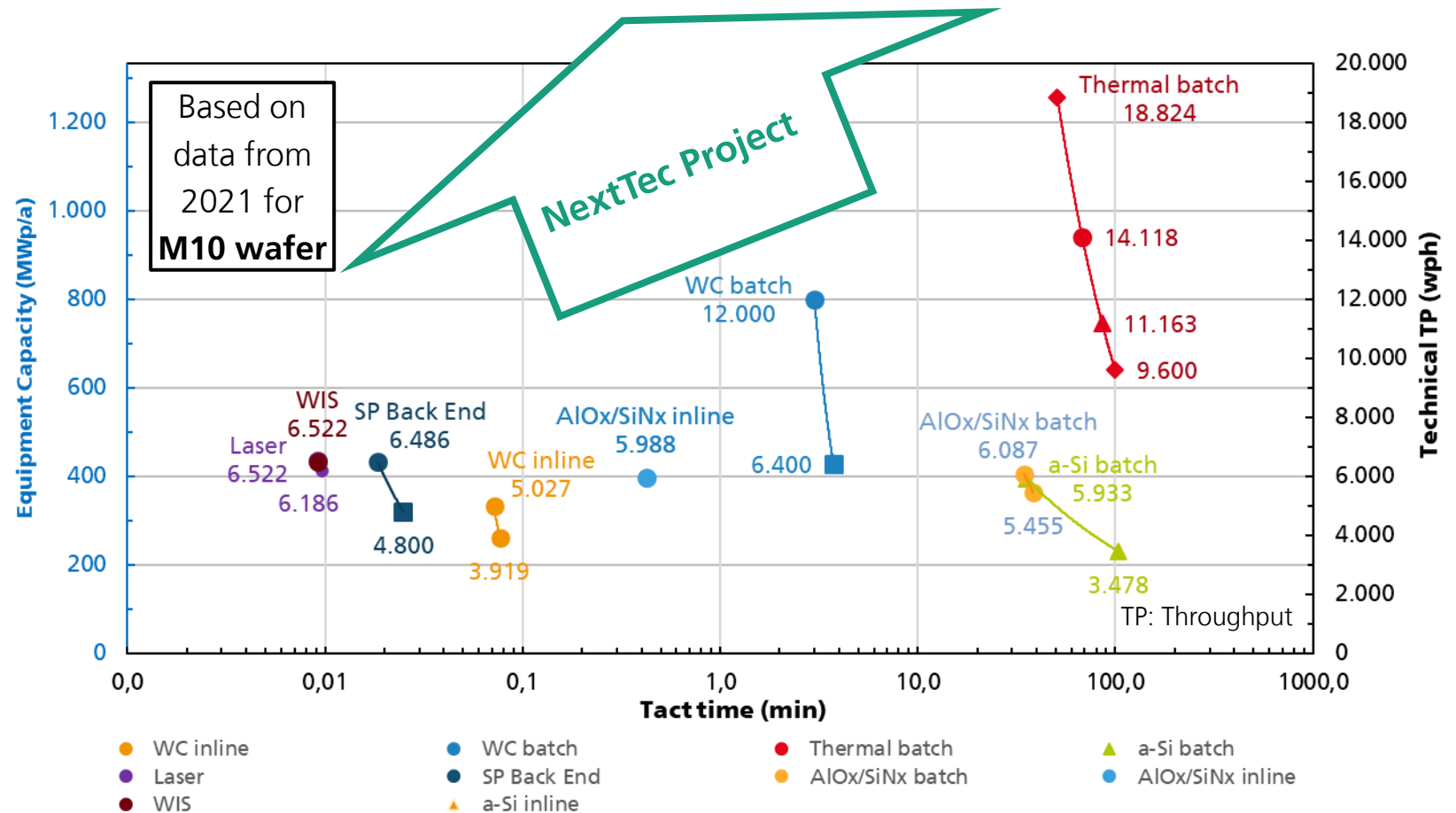
Aim of the NextTec Project



# High Throughput Production

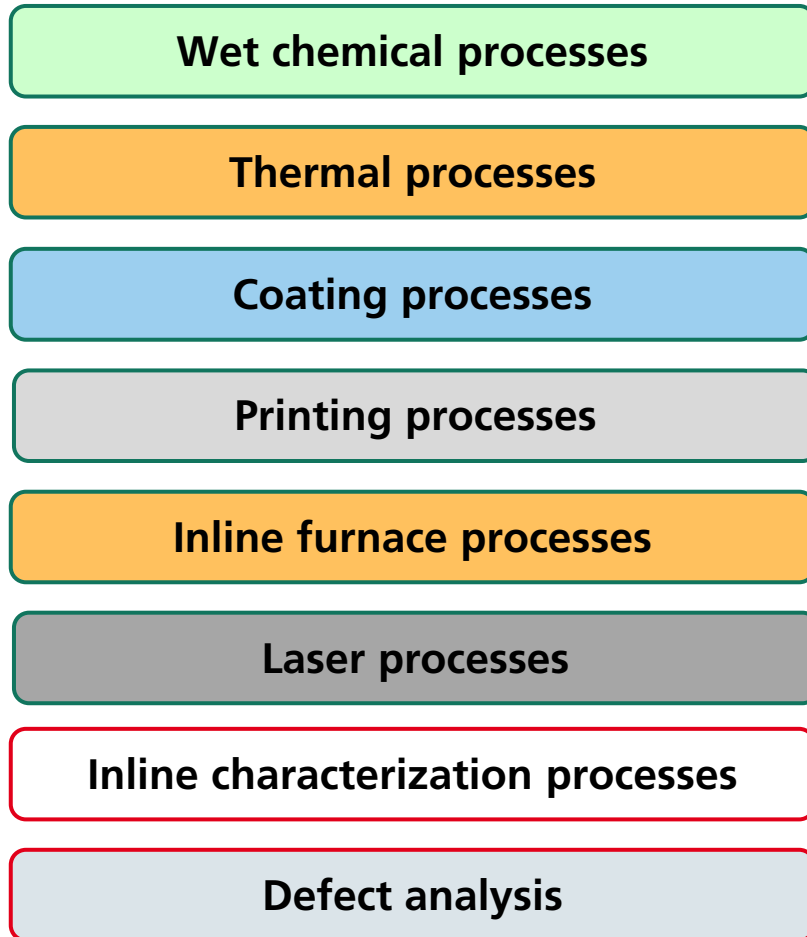
## Aim of the NextTec Project

- Increase throughput rates by factor 2 to 3
  - Similar cell efficiency
  - No significant increase in equipment footprint and costs
- System throughputs: > 13,000 wafers per hour (M10 wafer)
- Production capacity: > 1 GW per system and year



# High Throughput Production

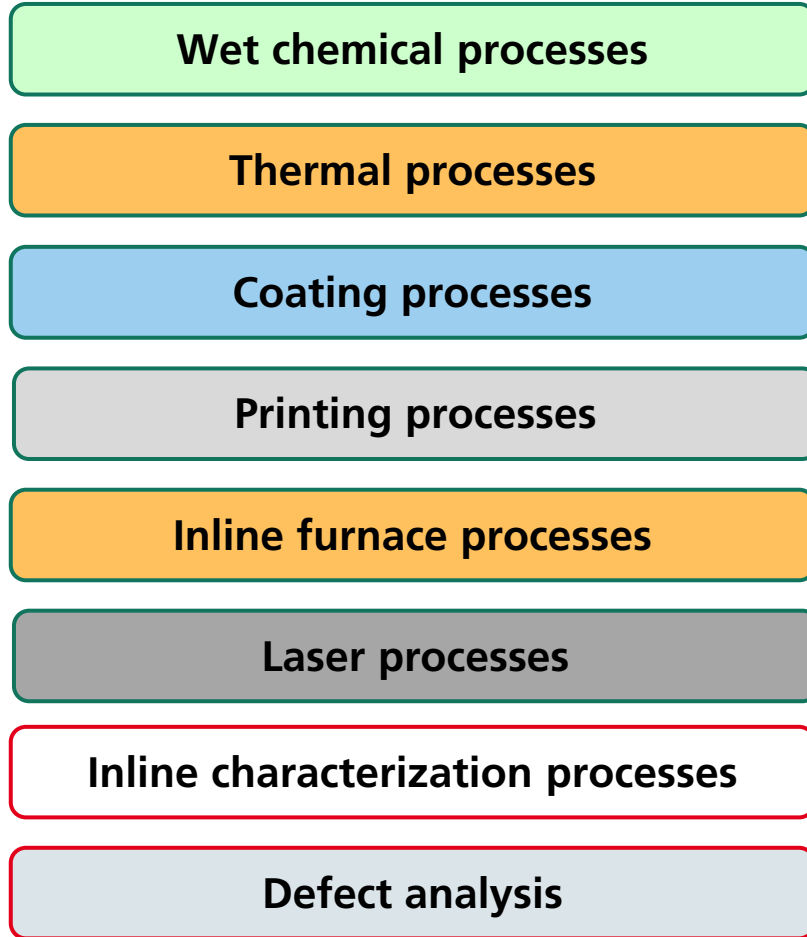
## NextTec Processes – Overview



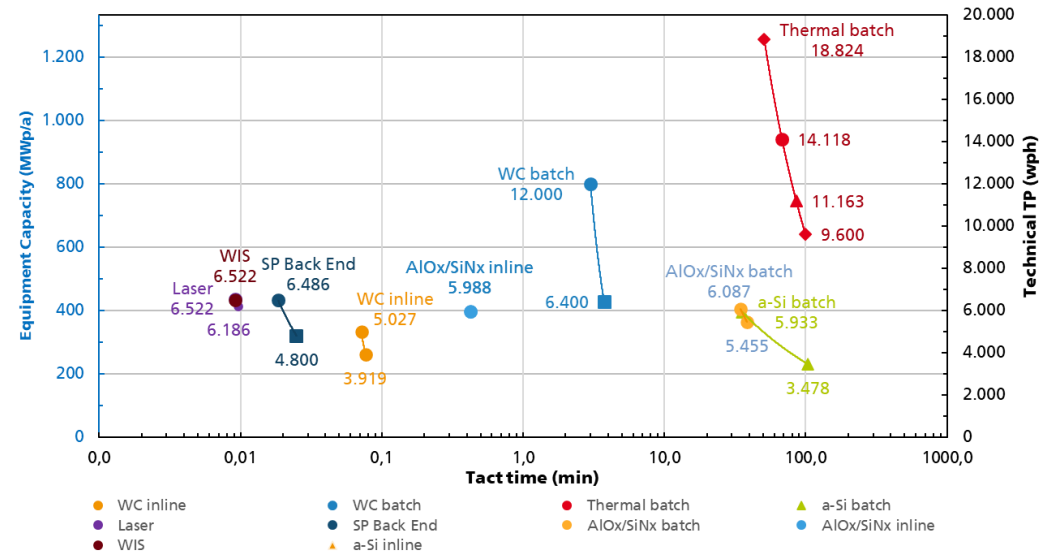


# High Throughput Production

## NextTec Processes – Overview



Techno-economic analysis [2a]: for all NextTec processes



[2a] PhD thesis Sebastian Nold, 2019

# High Throughput Production

## NextTec Processes – Overview

Wet chemical processes

Thermal processes

Coating processes

Printing processes

Inline furnace processes

Laser processes

Inline characterization processes

Defect analysis

NextTec Project

New concepts for (vertically passing) Si solar cells



For more information:

- Dannenberg et al., WCPEC-8 2022



# High Throughput Production

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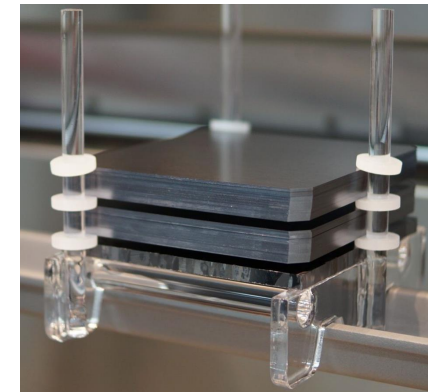
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NextTec Project

Stack diffusion with APCVD doping layers



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NextTec Project



High speed coating technologies: Spray pyrolysis, PVD



VON ARDENNE



For more information:

- Spray pyrolysis: Heitmann, Bartsch et al., WCPEC-8 2022
- PVD: Schneiderloechner et.al., WCPEC-8 2022

# High Throughput Production

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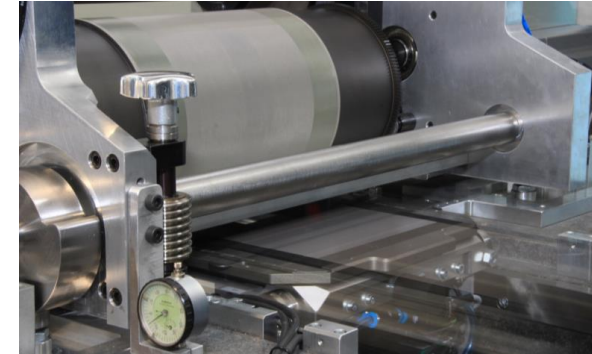
Inline furnace processes

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NextTec Project



Inline printing processes based on rotational printing



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High belt speeds and novel heating elements

 **Fraunhofer**  
ISE



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Printing processes

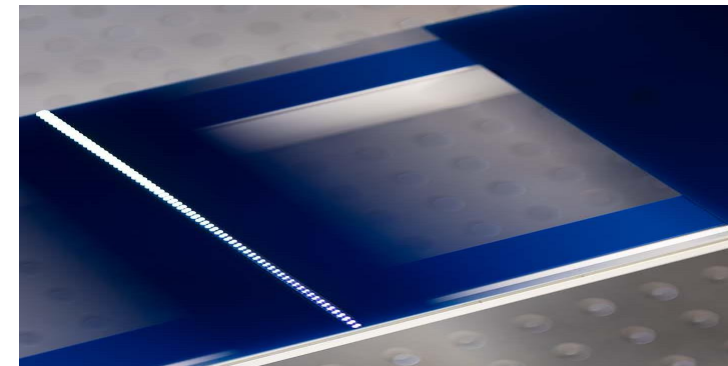
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NextTec Project



Inline laser processes with precise laser beam control

 **Fraunhofer**  
ISE

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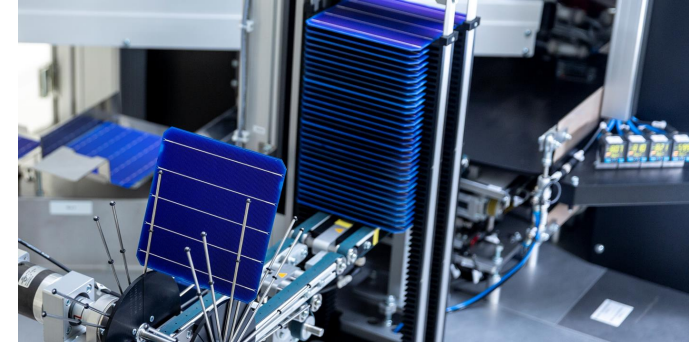
Inline furnace processes

Laser processes

Inline characterization processes

Defect analysis

NextTec Project



For more information:

- *IV* contactless: Kunze et al., WCPEC-8 2022
- *IV* / *EL* on-the-fly: Kurumundayil et al., WCPEC-8 2022

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ISE

**ISRA**  
VISION

 .h.a.l.m.

Innovative on-the-fly *IV* / *EL* testing; contactless *IV*

# High Throughput Production

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Wet chemical processes

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For more information:

- Buehler et al. , WCPEC-8 2022
- Koepge et al. , WCPEC-8 2022

 **Fraunhofer**  
CSP

**MecSim** HTWK

Mechanical influences of high throughput processes

# High Throughput Production

NextTec Processes – Focus in this talk

Wet chemical processes

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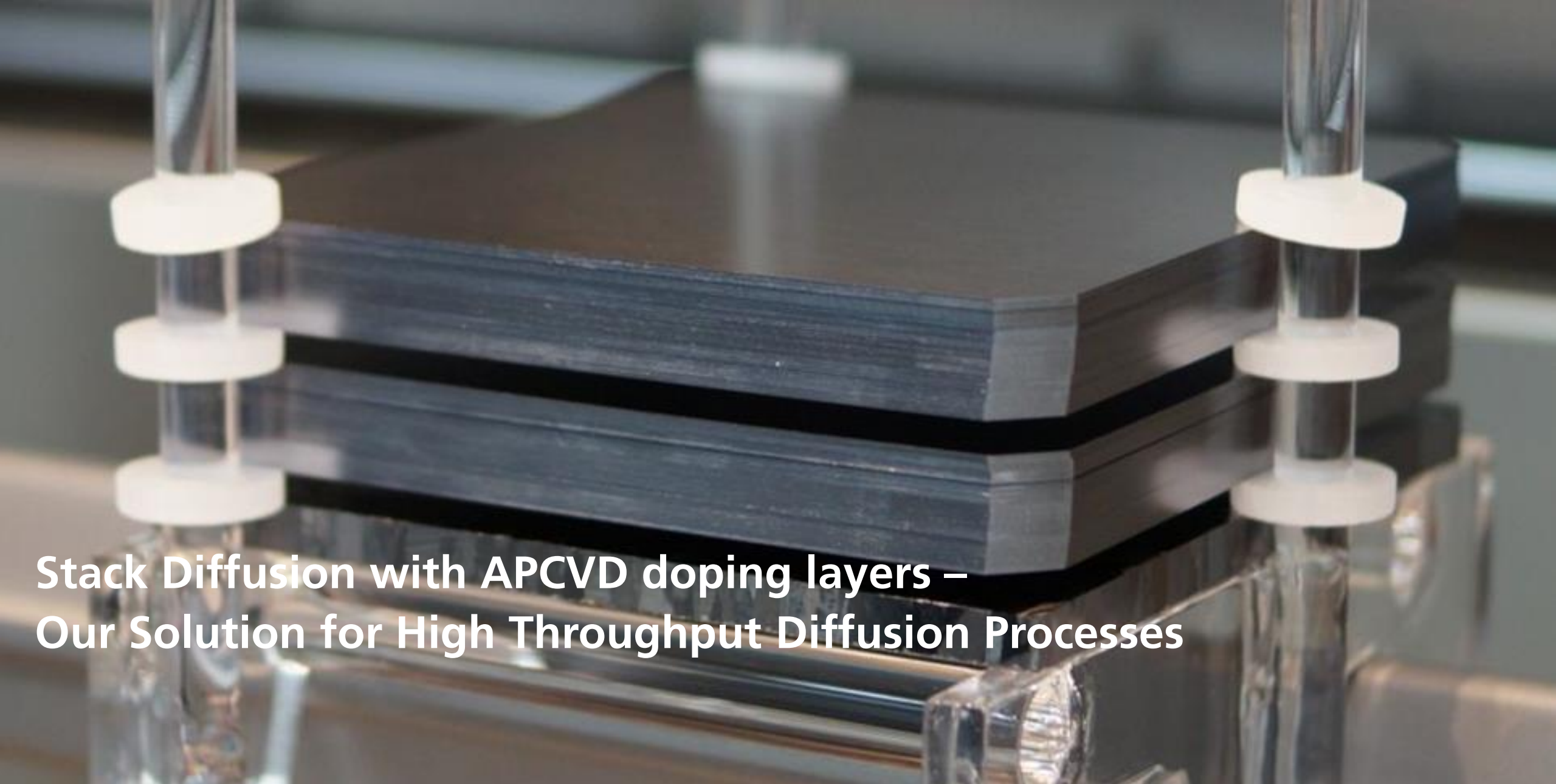
Stack diffusion with APCVD doping layers

Inline printing processes based on rotational printing

High belt speeds and novel heating elements

Inline laser processes with precise laser beam control

Innovative contactless *IV* testing



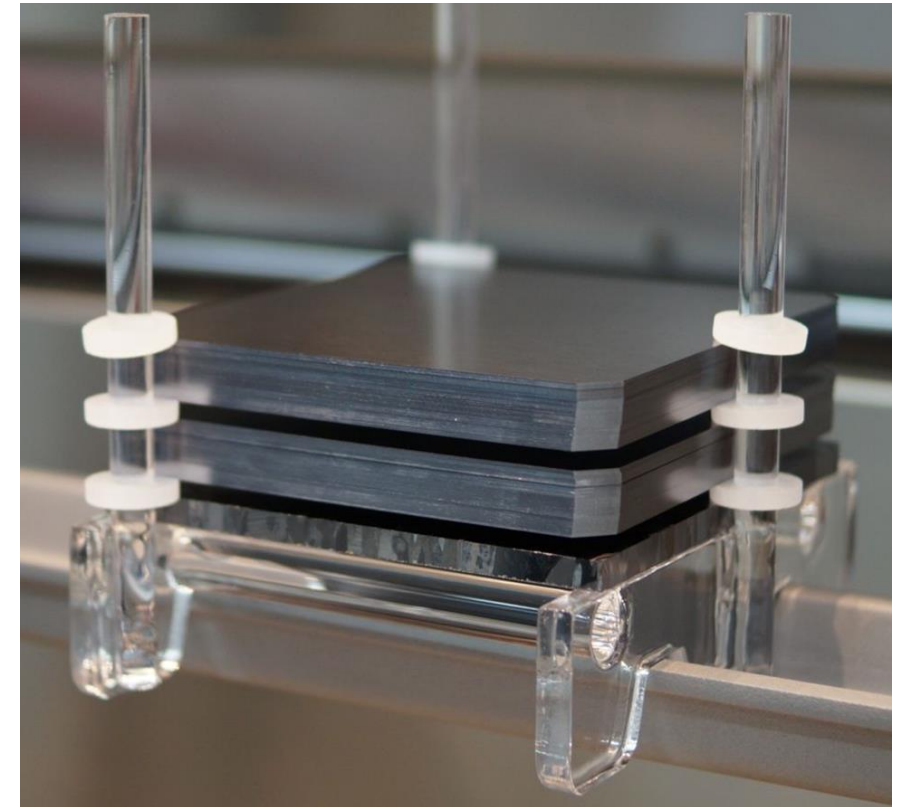
# Stack Diffusion with APCVD doping layers – Our Solution for High Throughput Diffusion Processes

# High Throughput Production

## Stack Diffusion / Oxidation [1]

- Stack oxidation / diffusion allows high throughput processes with similar quality
- Combination with pre-deposition of dopant sources e.g. by APCVD inline processing
- In total **6000 M10 Wafer per tube / process** (state of the art: approx. 1600 wafers)
- Almost similar cell efficiencies for TOPCon solar cells are reached, process optimization ongoing


Diffusion Configuration	$V_{OC}$ (mV)	$J_{SC}$ (mA/cm <sup>2</sup> )	FF (%)	$\eta$ (%)
BBr <sub>3</sub> reference	705	40.9	81.6	23,6
APCVD BSG stacked	700	40.8	81.4	23,1



Experimental setup for the stack diffusion in a special quartz boat

[2] Messmer et al, IEEE, 2022; Messmer et al. EUPVSEC 2021





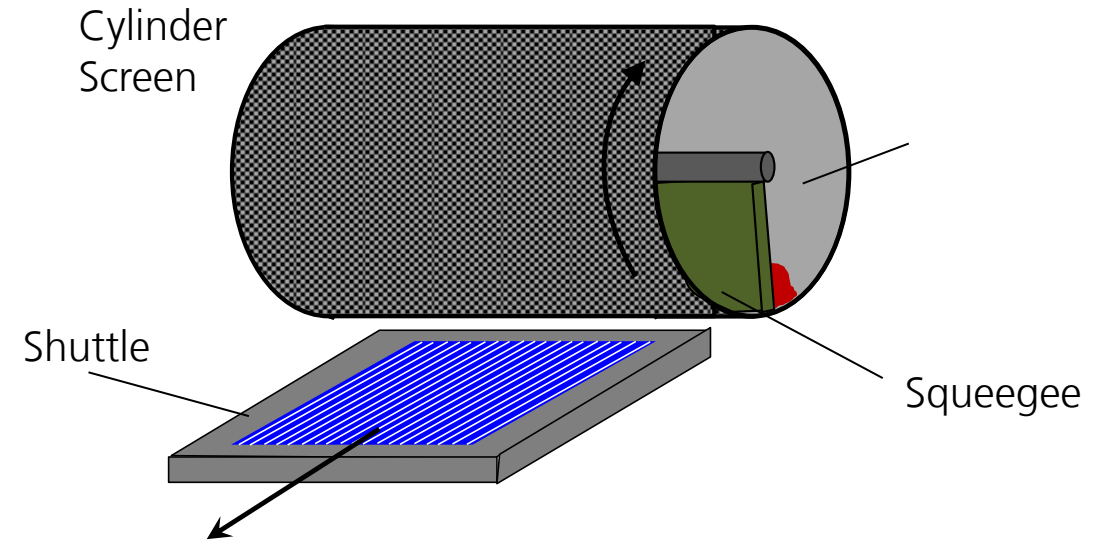
# Rotary Printing – Our Solution for High Throughput Printing Processes

# High Throughput Production

## Rotary Printing Processes [3]

- Innovative inline printing processes based on rotary screen printing
- Highly promising to overcome the throughput limit of flatbed screen printing

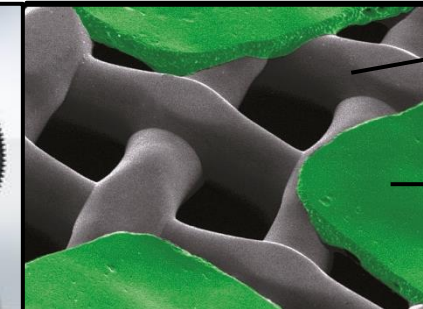
### Rotary Screen Printing:



### Rotary screen



Source: Gallus Ferd. Rüesch AG



**Open mesh**  
→ Printing

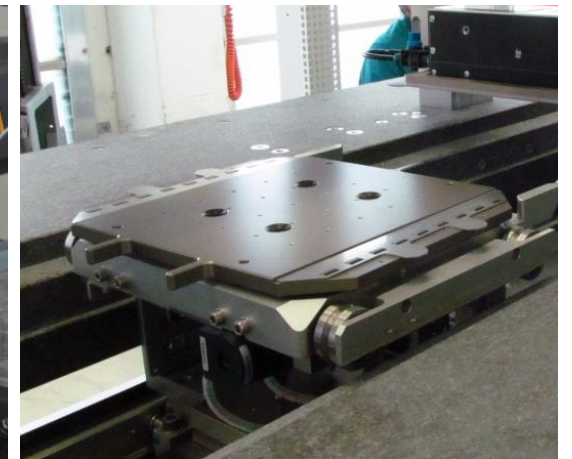
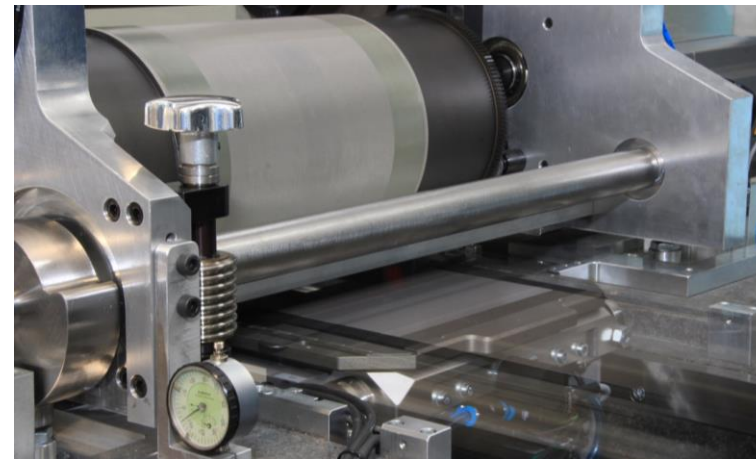
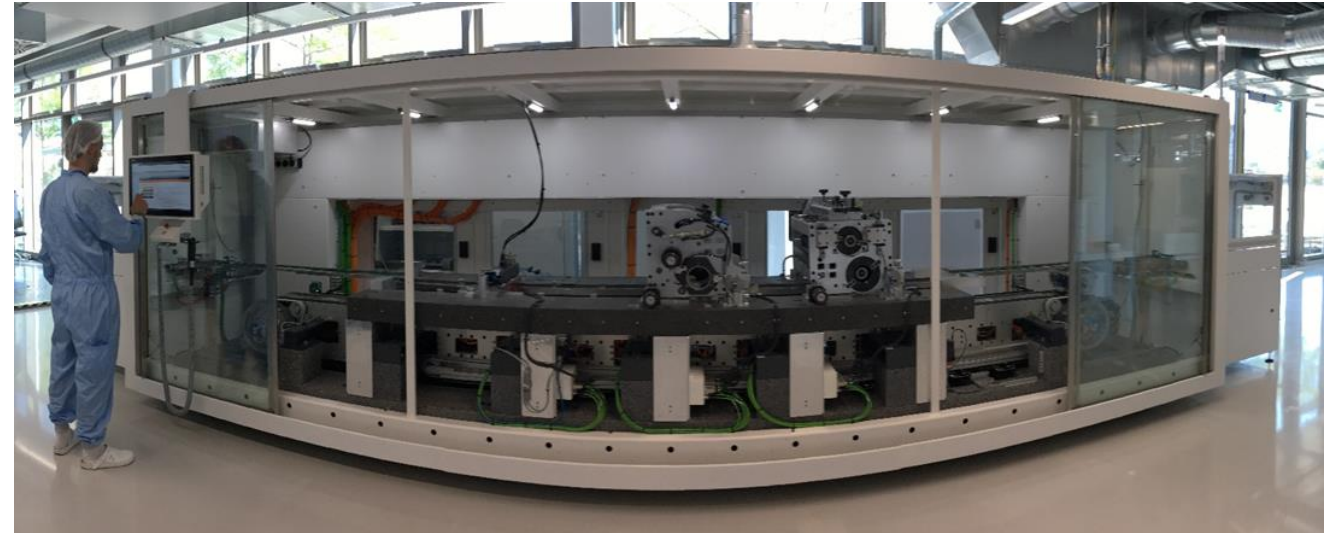
**Emulsion**  
→ Non-printing



# High Throughput Production

## Rotary Printing Processes [3]

- Innovative inline printing processes based on rotary screen printing
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- Our demonstrator machine allows throughput rates of **15.000 wafers per hour for double lane** (state of the art: approx. 6.500 wafers)

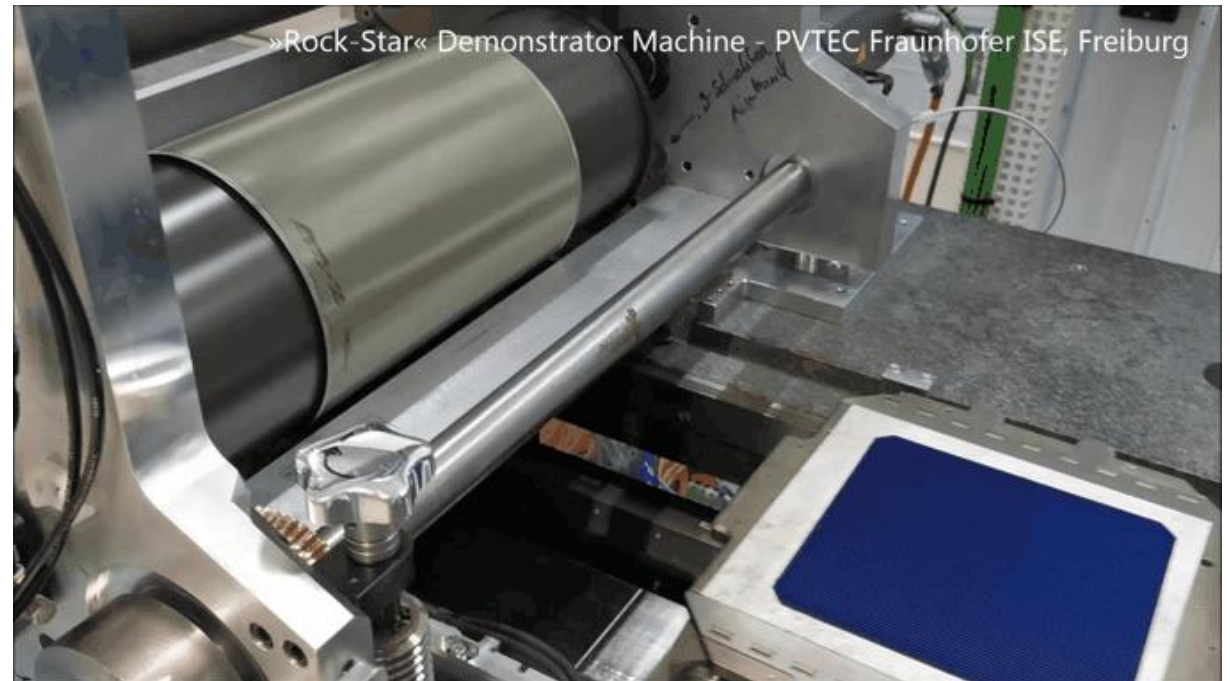


[3] Lorenz et al, Metallization Workshop, 2021

# High Throughput Production

## Rotary Printing Processes [3]

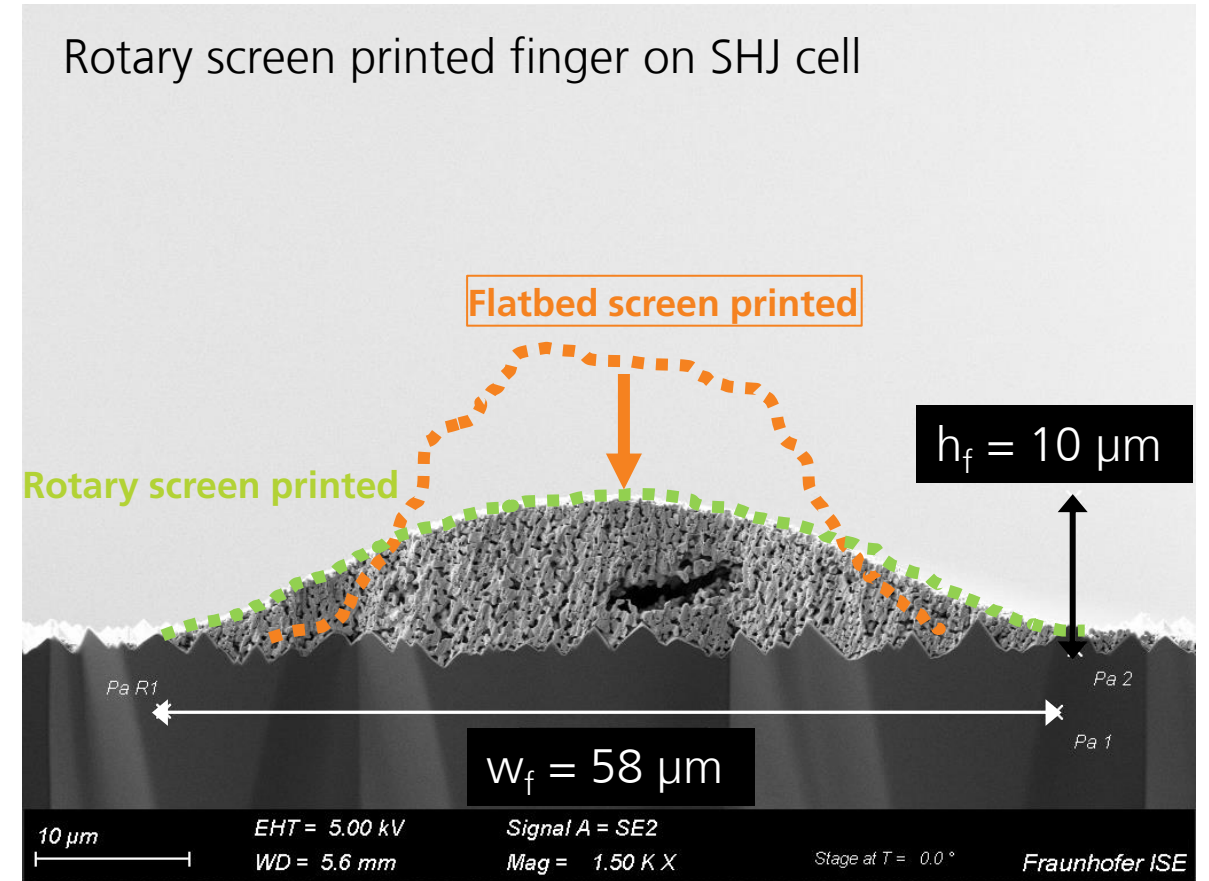
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- Rotary Printing allows silver paste reduction



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- Highly promising to overcome the throughput limit of flatbed screen printing
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- Rotary Printing allows silver paste reduction and similar efficiency level

Method	Avg/Best	Jsc [mA/cm <sup>2</sup> ]	Voc [mV]	FF [%]	η [%]
<b>Rotary SP (rear side)</b>	Avg	38.5	727	78.6	<b>22.0</b>
	Best Cell	38.7	729	79.4	22.2
<b>Flatbed SP (rear side)</b>	Avg	38.5	727	78.9	<b>22.1</b>
	Best Cell	38.7	731	79.7	22.4

Two groups of SHJ cells (approx. 20 cells per group)

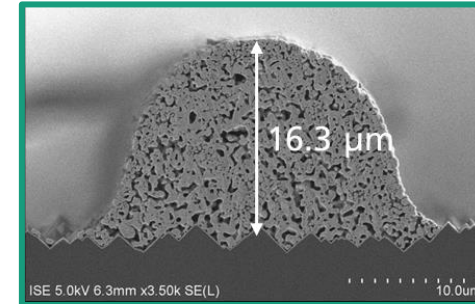
Performance of material (SHJ precursors) generally limited to around 22.5%



# High Throughput Production

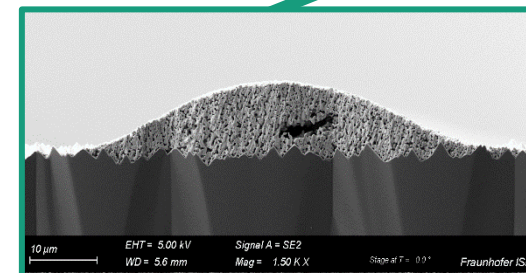
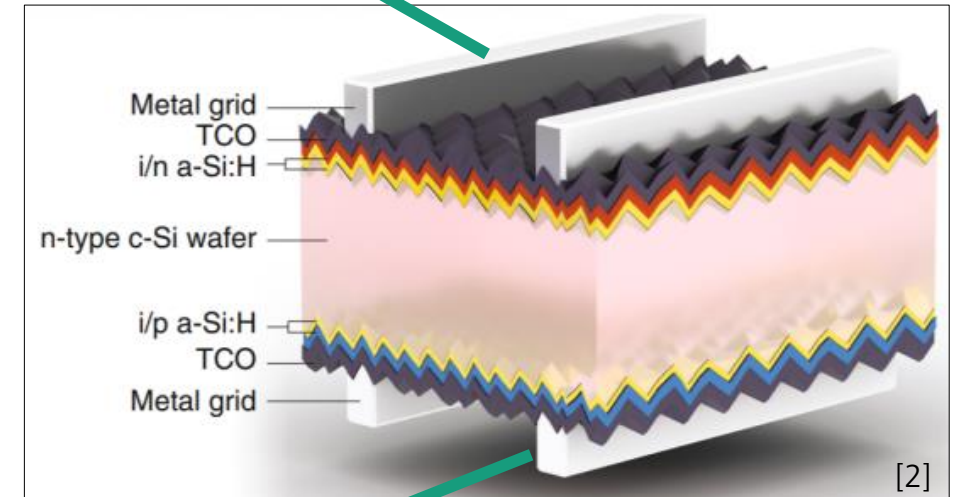
## Rotary Printing Processes [3]

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- Our demonstrator machine allows throughput rates of 15.000 wafers per hour for double lane (state of the art: approx. 6.500 wafers)
- Rotary Printing allows silver paste reduction and similar efficiency level
- Combination with Multi-Nozzle Dispensing very promising approach for high throughput cell metallization with reduced Ag consumption



**HIGHLINE**  
TECHNOLOGY

Dispensed LTP contact on SHJ solar cell [4]



Rotary printed LTP contact on SHJ solar cell

[3] Lorenz et al, Metallization Workshop, 2021; [4] Gensowski et al., 9th Metallization Workshop / AIP Conf. Proc. 2367 (2021)

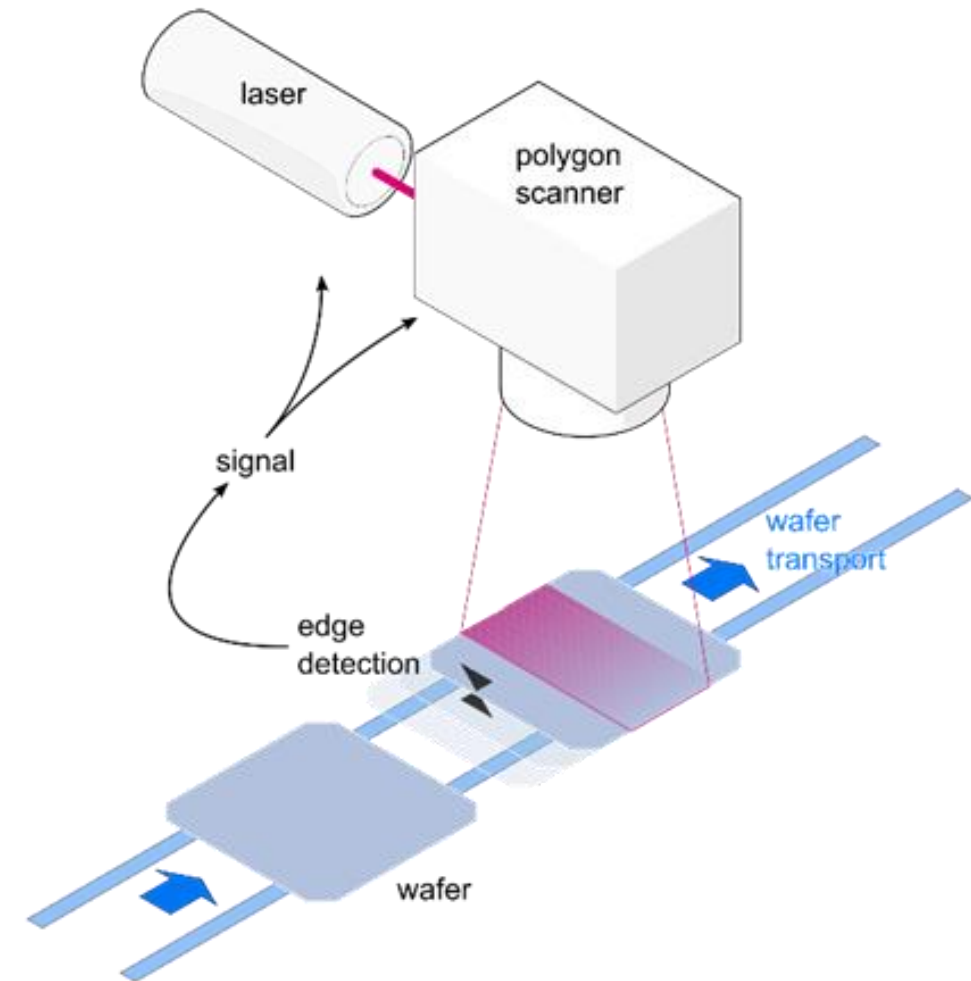


# „On the Fly“ Laser – Our Solution for High Throughput Laser Processes

# High Throughput Production

## „On The Fly“ Laser Processes [5]

- Novel inline “on the fly” laser processes with precise laser beam control
  - Simple conveyor belt
  - On-the-fly laser processing with polygon scanner
  - Location of the cell determined using optical sensor
  - Laser process automatically triggered upon arrival of the moving wafer



[5] press release Fraunhofer ISE #9 / 2022, 25.04.2022

# High Throughput Production

„On The Fly“ Laser Processes [5]

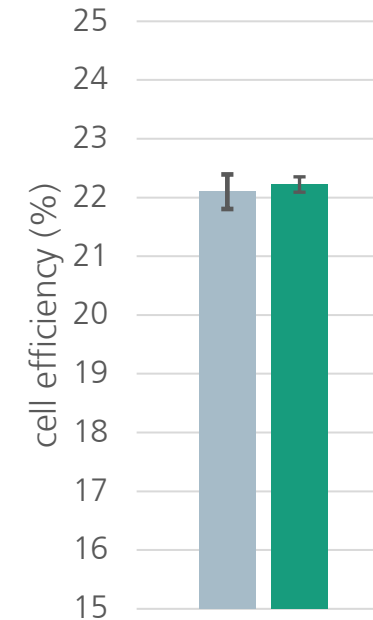


[5] press release Fraunhofer ISE #9 / 2022, 25.04.2022

# High Throughput Production

## „On The Fly“ Laser Processes [5]

- Novel inline “on the fly” laser processes with precise laser beam control
  - Simple conveyor belt
  - On-the-fly laser processing with polygon scanner
  - Location of the cell determined using optical sensor
  - Laser process automatically triggered upon arrival of the moving wafer
- New concept allows **throughput rates of 15.000 wafer per hour** (state of the art: approx. 6.500 wafer)
- Similar cell efficiency for PERC solar cells achieved



■ LCO reference process  
■ LCO “on the fly” laser process

[5] press release Fraunhofer ISE #9 / 2022, 25.04.2022





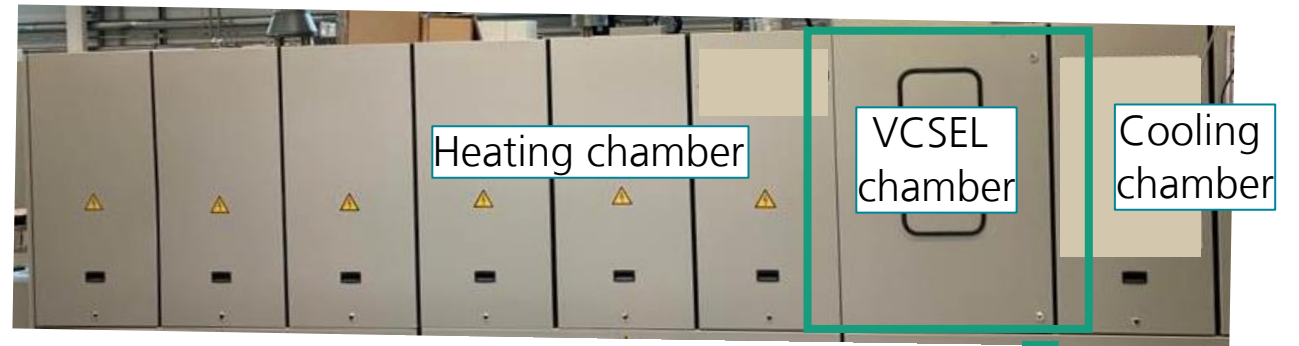
# High Throughput Inline Furnace Processes



# High Throughput Production

## Inline Furnace Processes – Approach A [6]

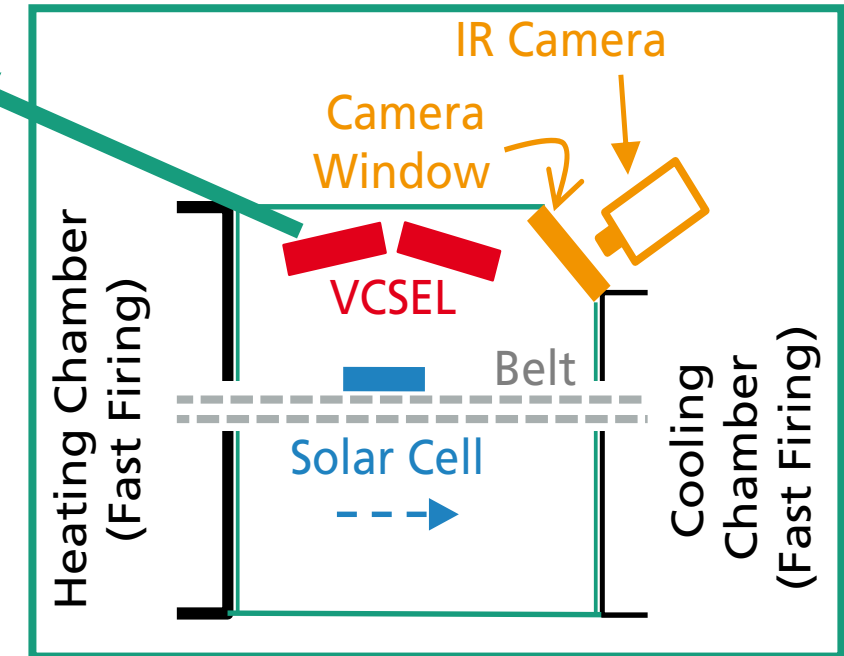
- Inline furnace processes with novel light sources, e.g. VCSEL modules, allow higher throughputs



Firing furnace at PV-TEC laboratory at Fraunhofer ISE



VCSEL module

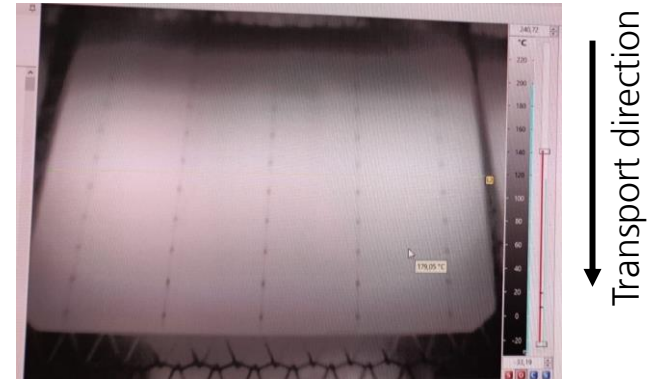


Lateral scheme of VCSEL heating equipment

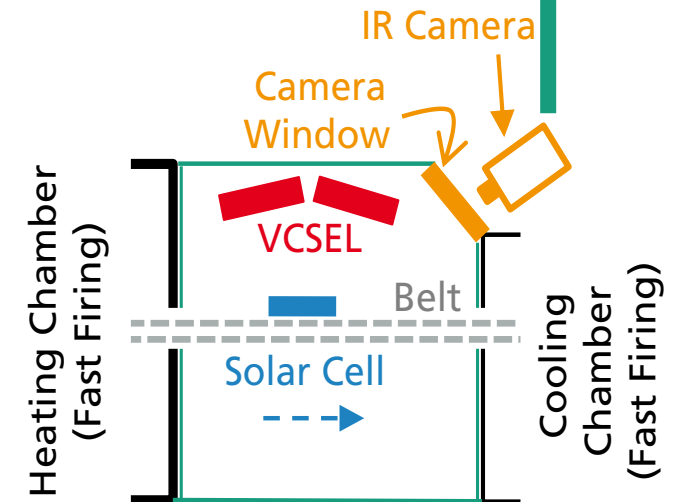
# High Throughput Production

## Inline Furnace Processes – Approach A [6]

- Inline furnace processes with novel light sources, e.g. VCSEL modules, allow higher throughputs
- Successful demonstration of short contact drying processes down to 5 s for PERC devices
- Thermography shows good process homogeneity



Thermography snapshot of a passing solar cell

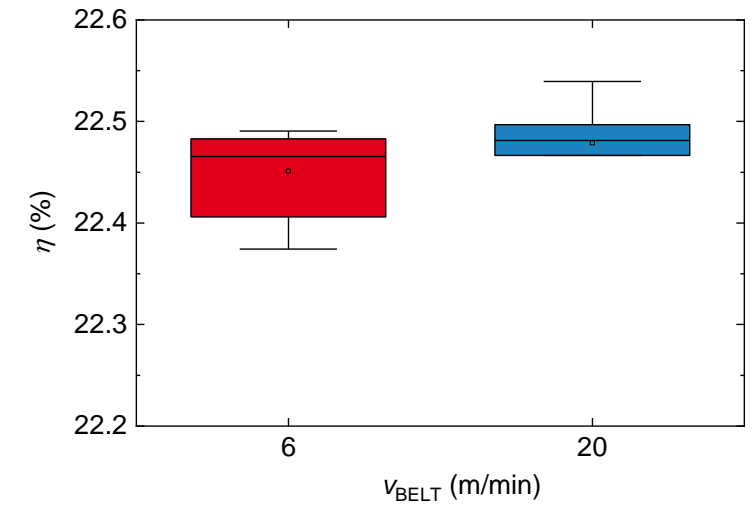
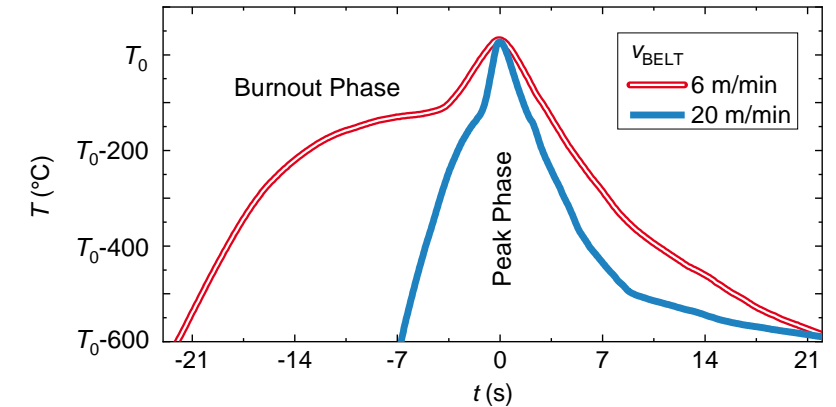


Lateral scheme of VCSEL heating equipment

# High Throughput Production

## Inline Furnace Processes – Approach B [7]

- Inline furnace processes with novel light sources, e.g. VCSEL modules, allow higher throughputs
- Successful demonstration of short contact drying processes down to 5 s for PERC devices
- Thermography shows good process homogeneity
- Inline furnace processes with belt speeds up to 20 m/min
- Similar cell efficiencies for contact firing (PERC)
- **Throughput of approx. 13000 wafers/h for dual lane** (state of the art: approx. 6.500 wafer)





# Contactless IV Measurement – Our Solution for High Throughput Cell Testing



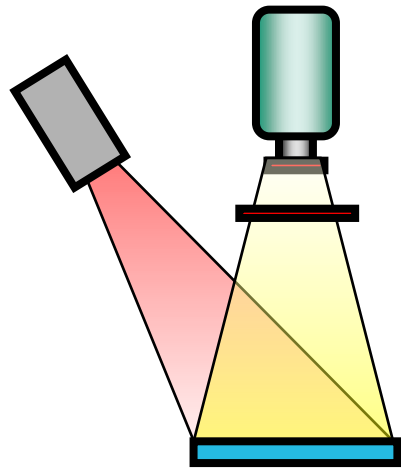
# High Throughput Production

## Inline *I/V* Characterization Contactless [8]

### Contactless Current-Voltage Measurement

#### Pseudo-*I/V* Characteristics

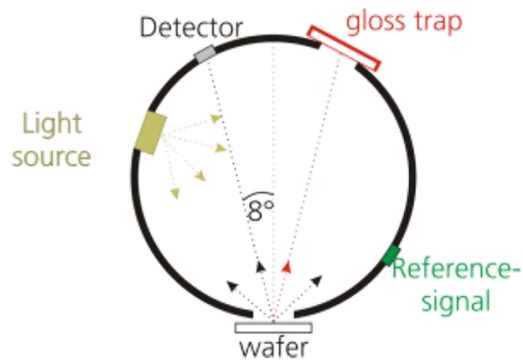
##### Sun-Photoluminescence



#### Short-Circuit Current

##### Reflectance

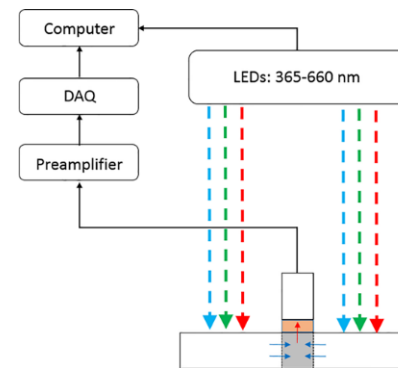
##### Spectrophotometry



##### Relative EQE

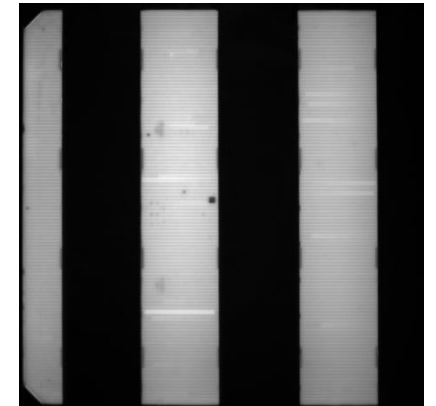
##### Contactless Electroluminescence Spectroscopy

[A. Paduthol, et al., JAP, 2018]



#### Series Resistance

##### Partially Shaded Photoluminescence

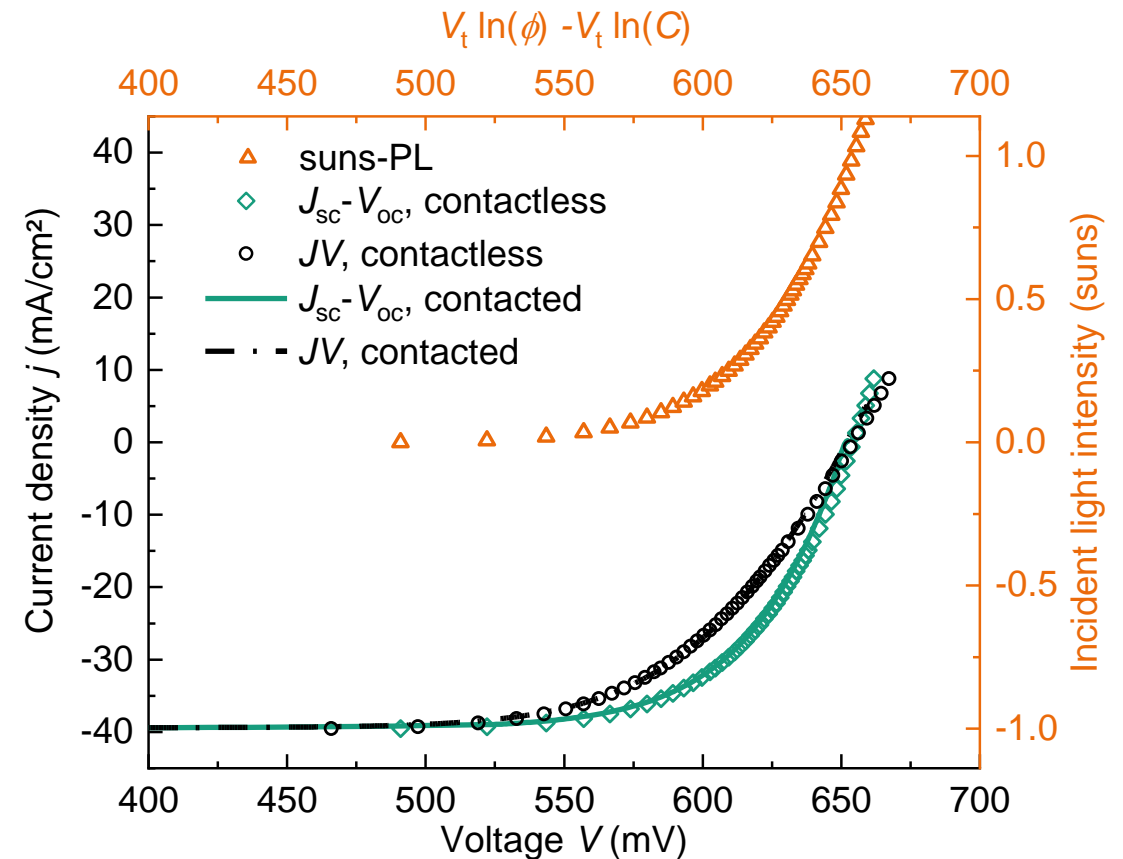


[8] Greulich et al., Silicon PV, 2022

# High Throughput Production

## Inline $I/V$ Characterization Contactless [8]

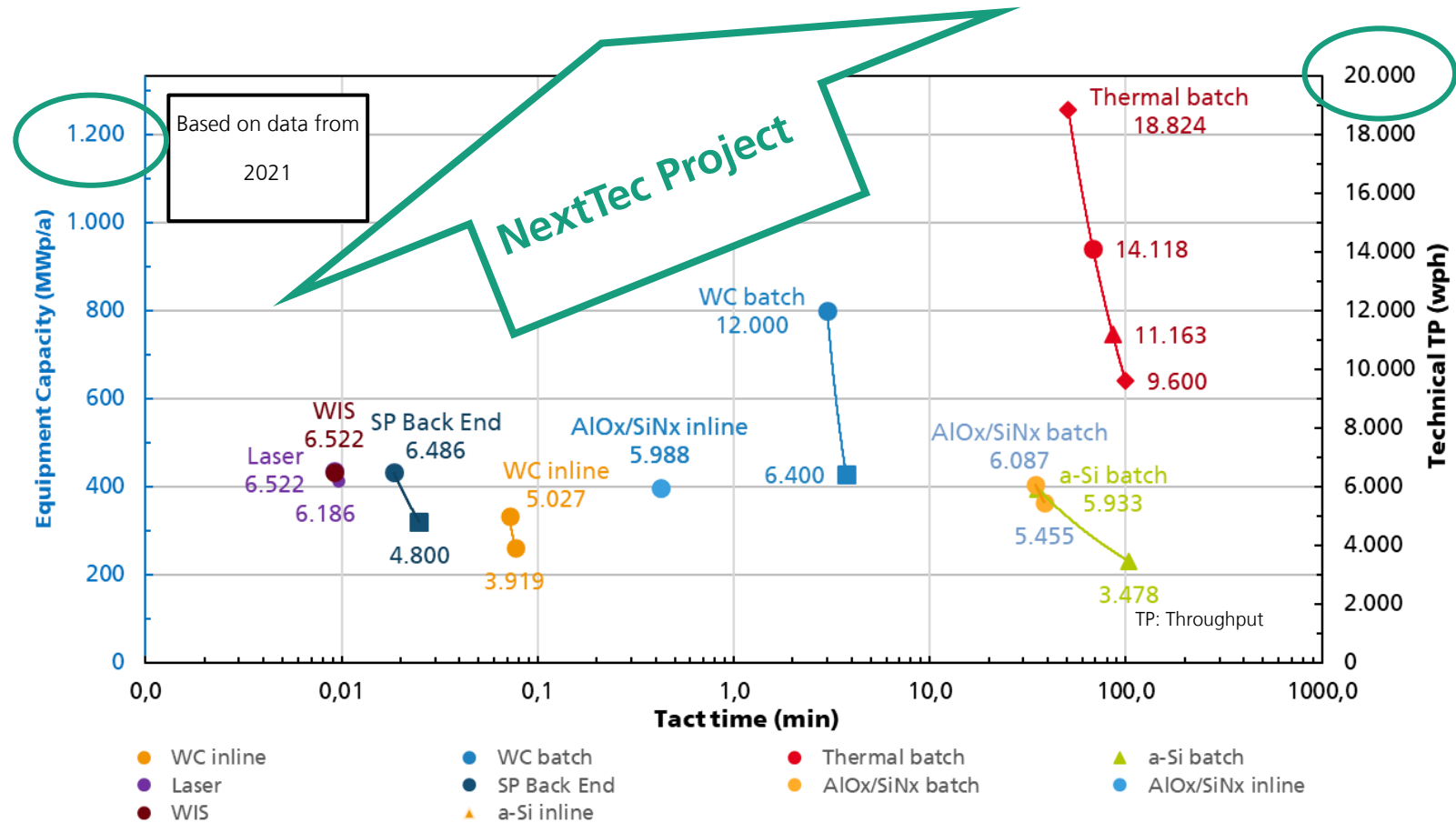
- Contactless  $I/V$  Characterization
  - Suns-PL data calibrated to voltage
  - Shift suns-PL to get pseudo- $I/V$  or  $J_{SC}-V_{OC}$  curve
  - Account for series resistance  $\gg$   $JV$  contactless
- Close match with conventionally measured  $JV$  curve
- Proof of principle successful
- **Measurement speed limited by cell physics, not by metrology  $\gg$  high throughput rates achievable**





# High Throughput Production

## NextTec Processes – Conclusion

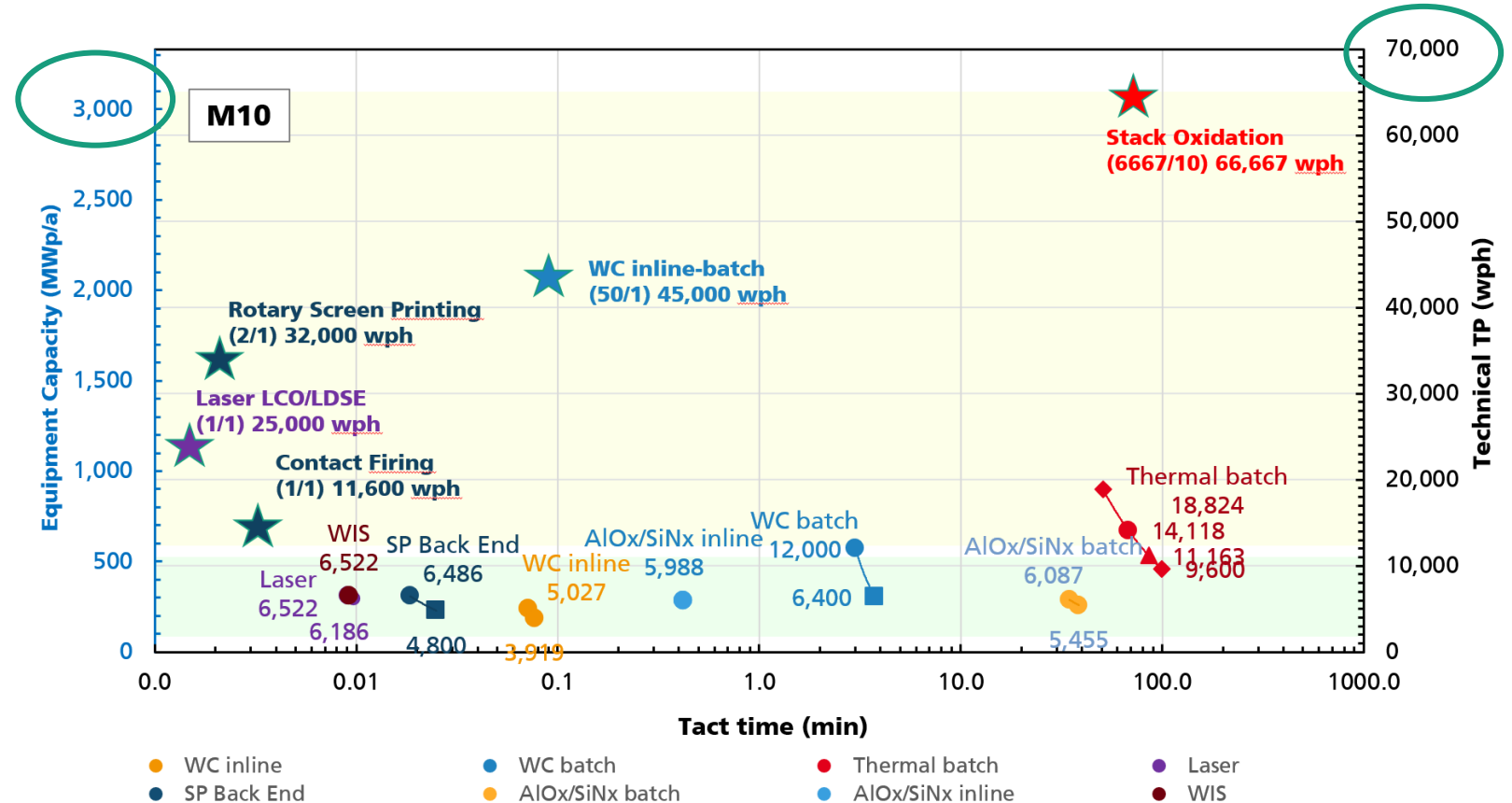


# High Throughput Production

## NextTec Processes – Conclusion

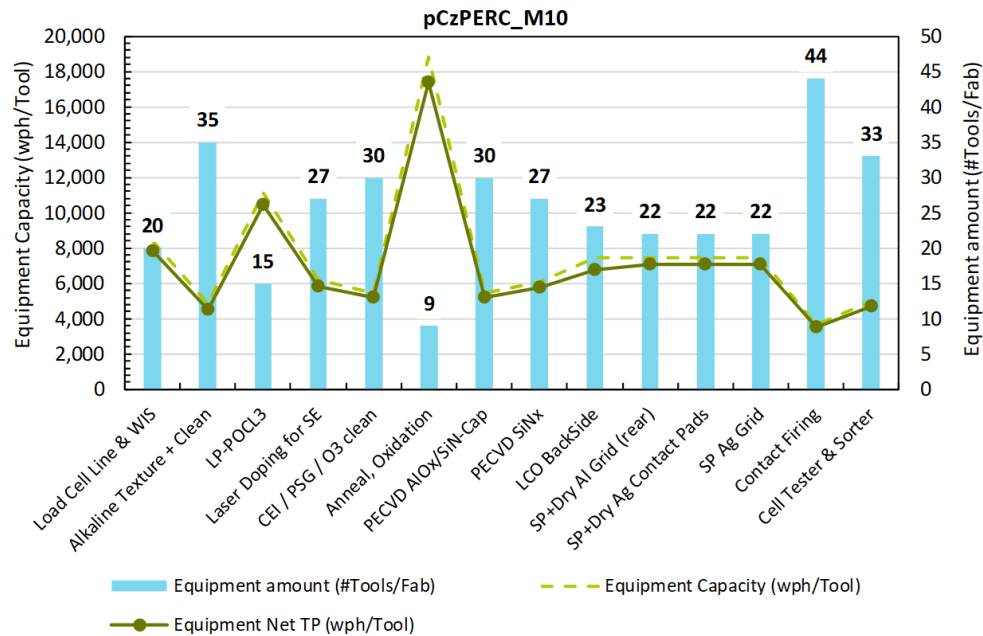


- New solutions for high throughput processes and equipment developed
- Throughput rates  $\gg$  10.000 wafer per hour and system demonstrated within the NextTec project
- New processes allow (almost) the same efficiency level
- Equipment capacity  $>$  1GW is reachable

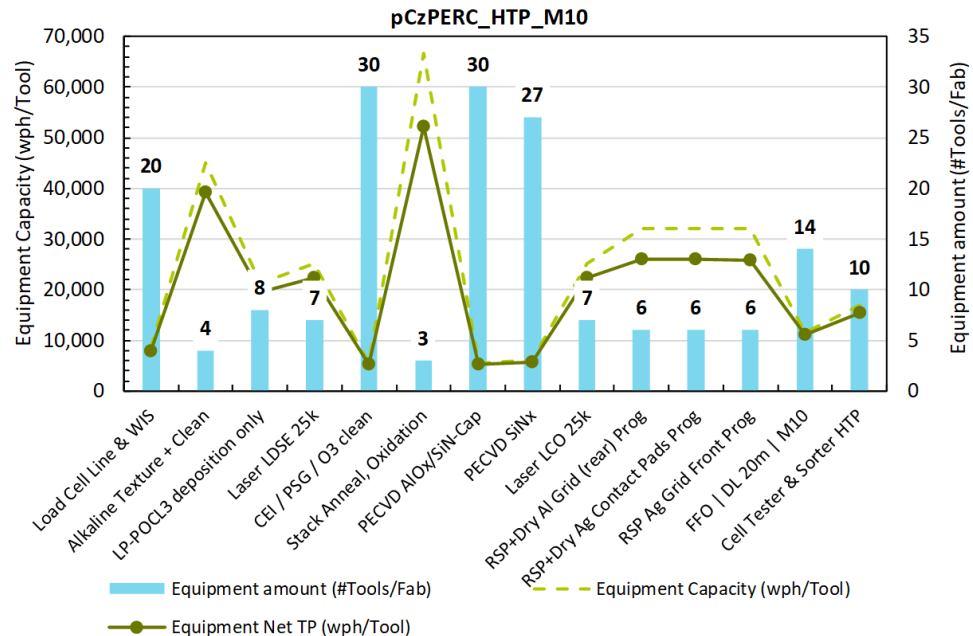


# High Throughput Production

## NextTec Processes – Our Vision [9]



**PERC Reference**      **359 Tools per 10,1 GWp-Fab**  
**35.4 Tools / GWp**



**PERC HTP**      **178 Tools per 10,1 GWp-Fab**  
**17,6 Tools / GWp → -50% lesser Equipment with HTP**

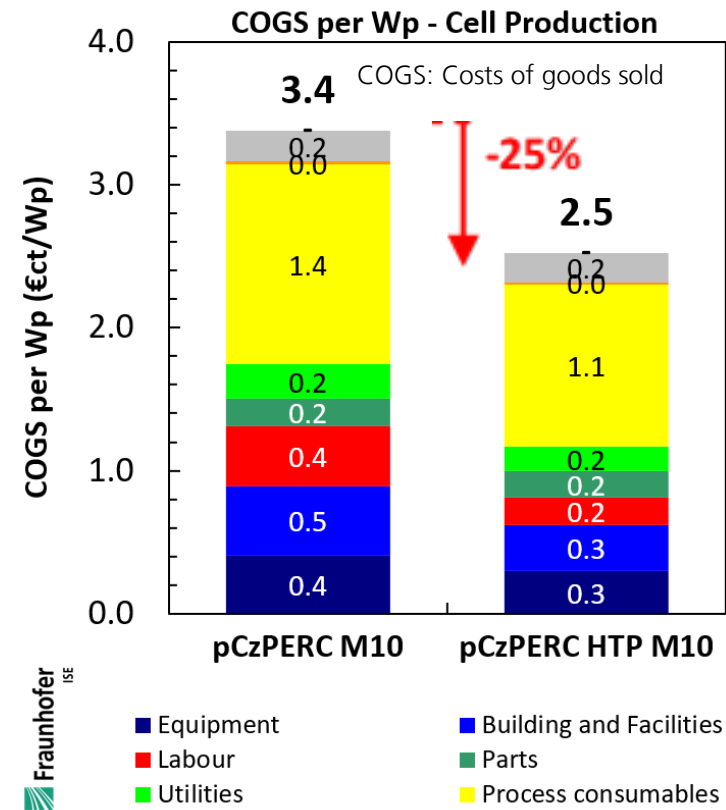
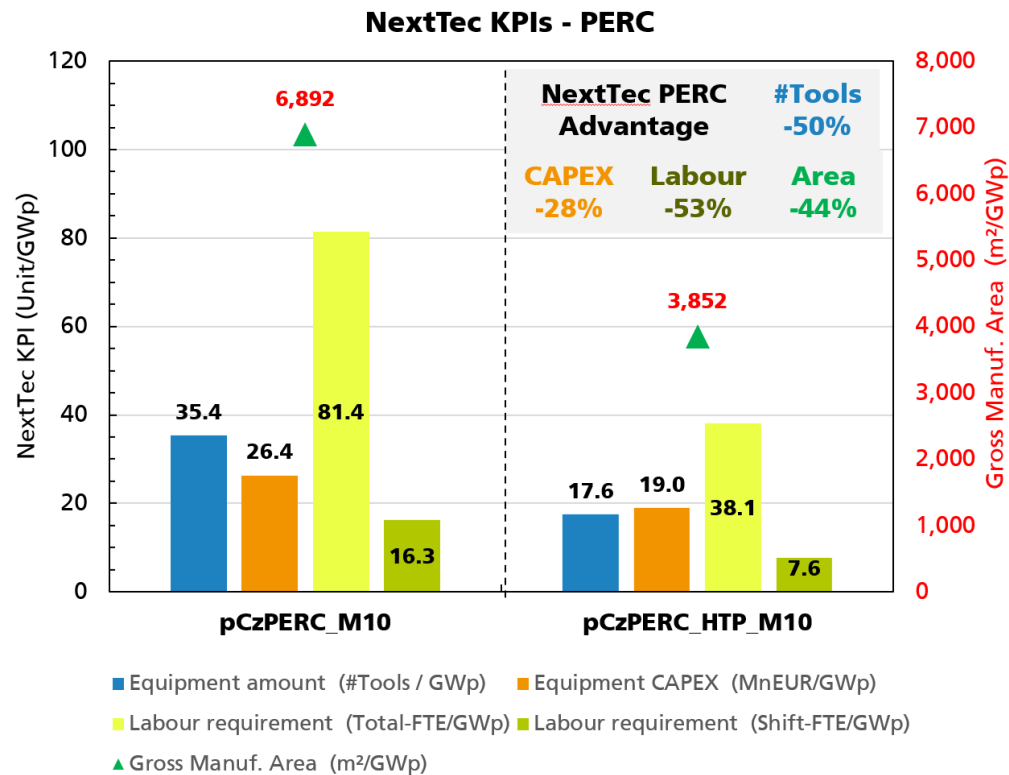
**Vision:** Implementation and demonstration of NextTec Processes in a running cell production line\* to realize production cost savings → **Number of production tools reduced by approx. 50%**

\*Assumption: 10 GWp PERC production line for M10 wafers

[8] Goraya et al., EUPVSEC 2023, submitted

# High Throughput Production

## NextTec Processes – Our Vision [9]



**Vision:** Implementation and demonstration of NextTec Processes in a running cell production line\* to realize production cost savings: #tools, CAPEX, labour costs and production line area reduced → **Total Cost of Ownership reduced by approx. 25%**

\*Assumption: 10 GWp PERC production line for M10 wafers

# Many thanks to all my co-authors Thank you for your attention!

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link to Fraunhofer ISE contributions of  
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